IPC ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	© Copyright 2005. IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.							
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				ials and Mfc Information				
upplier Inforn	1 1 3											
Company name*			Company unique ID			Unique ID Authority			Response Date*			
nsemi									2024-04-16			
Contact Name			Title - Contact			Phone - Contact*			Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			Phone - Representative*			Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com			
Request	er Item Number	Mfr Item Number	Mfr Item Name	Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type	
		AMIS30422C422N WG	INT 0C422-OAA AM	IIS30422 FOR	S	2024-04-16		PHG	152.53	mg	Each	
Ianufacturing	Process Informatio	n										
Terminal	Terminal Plating / Grid Array Material Terminal		minal Base Alloy J-STD-020 MSL Ra		SL Rating	Peak Process Body Temperature Max Time at Pe		ature Max Time at Peak	ak Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed		CU Alloy	CU Alloy 3			260	C	30	seconds 3			
omments												
TTENTION: MS	L 3 Rated item requires B	sake and Dry Pack (fter electrical test)									
or more informat	ion regarding material co	mposition please ref	er to page 3	•		_	•		_	_		

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of					
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	13.43	mg	Supplier	Silicon (Si)	7440-21-3		13.43	mg
Die Attach	5.51	mg	Supplier	Silver (Ag)	7440-22-4		4.1325	mg
			Supplier	Epoxy resins	129915-35-1		1.3775	mg
Lead Frame	82.15	mg	Supplier	Zinc (Zn)	7440-66-6		0.0822	mg
			Supplier	Iron (Fe)	7439-89-6		1.8895	mg
			Supplier	Copper (Cu)	7440-50-8		80.0963	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0821	mg
Mold Compound-Black	46.53	mg		Epoxy Phenol Resin	proprietary data		6.9795	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		39.5505	mg
Plating	3.32	mg	Supplier	Tin (Sn)	7440-31-5		3.32	mg
Wire Bond - Au	1.59	mg	Supplier	Gold (Au)	7440-57-5		1.59	mg